

PRODUCT / PROCESS CHANGE INFORMATION

1. PCI basic data

1.1 Company		STMicroelectronics International N.V
1.2 PCI No.	AMS/19/11725	
1.3 Title of PCI	New Test location for products assembled in MSOP and TSSOP 8 package	
1.4 Product Category	See product list	
1.5 Issue date	2019-09-02	

2. PCI Team

2.1 Contact supplier	
2.1.1 Name	ROBERTSON HEATHER
2.1.2 Phone	+1 8475853058
2.1.3 Email	heather.robertson@st.com
2.2 Change responsibility	
2.2.1 Product Manager	Lorenzo NASO
2.1.2 Marketing Manager	Massimiliano MERISIO
2.1.3 Quality Manager	Sergio Tommaso SPAMPINATO

3. Change

3.1 Category	3.2 Type of change	3.3 Manufacturing Location
Transfer	Line transfer for a full process or process brick (process step, control plan, recipes) from one site to another site: Testing (SOP 2617)	Test & Finishing : Subcontractor TSHT China

4. Description of change

	Old	New
4.1 Description	Assembly site : Subcontractor Amkor Philippines	Assembly site : Subcontractor Amkor Philippines Test & Finishing : Subcontractor TSHT China
4.2 Anticipated Impact on form,fit, function, quality, reliability or processability?	No impact	

5. Reason / motivation for change

5.1 Motivation	The purpose of the introduction of TSHT for Test & Finishing activities is to further improve the rationalization of our manufacturing assets, provide a better support to our customers by enhancing the manufacturing process for higher volume production.
5.2 Customer Benefit	CAPACITY INCREASE

6. Marking of parts / traceability of change

6.1 Description	New finished good codes
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7. Timing / schedule

7.1 Date of qualification results	2019-08-12
7.2 Intended start of delivery	2019-11-20
7.3 Qualification sample available?	Upon Request

8. Qualification / Validation

8.1 Description	11725 11725_TSHT test.zip		
8.2 Qualification report and qualification results	Available (see attachment)	Issue Date	2019-09-02

9. Attachments (additional documentations)
11725 Public product.pdf 11725 11725_TSHT test.zip

10. Affected parts		
10. 1 Current		10.2 New (if applicable)
10.1.1 Customer Part No	10.1.2 Supplier Part No	10.1.2 Supplier Part No
L6920DBTR	L6920DBTR	
	L6920DCTR	
L6926013TR	L6926013TR	
L6928D013TR	L6928D013TR	

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Public Products List

Public Products are off the shelf products. They are not dedicated to specific customers, they are available through ST Sales team, or Distributors, and visible on ST.com

PCI Title : New Test location for products assembled in MSOP and TSSOP 8 package

PCI Reference : AMS/19/11725

Subject : Public Products List

Dear Customer,

Please find below the Standard Public Products List impacted by the change.

L6926013TR	L6928D013TR	L6920DCTR
L6920DBTR		



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